

14May07 Rev B

FPC/FFC Connector, ZIF, 0.50mm Pitch, SMT Type

1. SCOPE

1.1. CONTENTS

This specification covers the performance, tests and quality requirements for the FPC/FFC, ZIF, 0.50mm Pitch, SMT Connector.

1.2. QUALIFICATION

When tests are performed on the subject product line, the procedures specified in Tyco 109 series specifications shall be used. All inspections shall be performed using the applicable inspection plan and product drawing.

2. APPLICABLE DOCUMENT

The following Tyco documents form a part of this specification to the extent specified herein. Unless otherwise specified, the latest edition of the document applies. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In the event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

2.1. TYCO SPECIFICATIONS

A. 109-1: General Requirements for Test Specifications

B. 109-197: Tyco Specification vs EIA and IEC Test Methods

C. 501-57364: Test Report

3. REQUIREMENTS

3.1. DESIGN AND CONSTRUCTION

Product shall be of the design, construction and physical dimensions specified on the applicable product drawing.

3.2. MATERIALS

A. Housing: Thermoplastic, UL94V-0

B. Contact: Copper Alloy, Gold plating on contact area over nickel underplating overall.

C. Actuator: Thermoplastic, UL94V-0

D. Tab: Copper Alloy, Tin plating on soldertail over nickel underplating overall.

3.3. RATINGS

A. Voltage: 50 VAC rms. B. Current: 0.5 A Max

C. Temperature: - 20 $^{\circ}\! C$ to 85 $^{\circ}\! C$



3.4. PERFORMANCE REQUEIREMENT AND TEST DESCRIPTION

The product shall be designed to meet the electrical, mechanical and environmental performance requirements specified in Figure 1. All tests shall be performed at ambient environmental conditions per AMP Specification 109-1TEST REQUIREMENTS AND PROCEDURES SUMMARY.

3.5. TEST REQUIREMENTS AND PROCEDURES SUMMARY

TEST ITEM		REQUIREMENT	PROCEDURE									
1	Examination of Product	Meets requirements of product drawing. No physical damage.	Visual inspection.									
	ELECTRICAL REQUIREMENT											
2	Contact Resistance	40 m Ohm Max(Initial) 60 m Ohm Max(Final)	Subject mated contacts assembled in housing to 20mV Max open circuit at 10mA Max. EIA-364-6B.									
3	Dielectric withstanding Voltage	No creeping discharge or flashover shall occur. Current leakage: 0.5 mA MAX	250 VAC for 1minute Test between adjacent circuits of unmated connector. EIA-364-20B									
4	Insulation Resistance	500 M Ohm Min.(Initial) 100 M Ohm Min.(Final)	Impressed voltage 500 VDC. Test between adjacent circuits of unmated connector. EIA-364-21C.									
MECHANICAL REQUIREMENT												
5	FPC Cable Retention Force	0.050 kgf/Pin Min.	Operation Speed: 10 mm/min. Measure the force required to mate connector. EIA-364-13B									
6	Vibration	No electrical discontinuity greater than 1 μ sec shall occur. See Note.	Subject mated connectors to 10-55-10 Hz traversed in 1minutes at 1.52mm amplitude 2 Hours each of 3 mutually perpendicular planes. 100mA Max. Applied. EIA-364-28D, Condition I									
7	Mechanical Shock	No electrical discontinuity greater than 1 μ sec shall occur. See Note.	Accelerate Velocity: 490m/s ² (50G) Waveform: Half-sine shock plus Duration: 11msec No. of Drops: 3 drops each to normal and reversed directions of X,Y and Z axes, totally 18 drops, passing DC 100mA max. current during the test. EIA-364-27B, Method A									
8	Solder ability	The inspected area of each lead must have 95% solder coverage minimum.	 Steam Aging Preconditioning: 1. Intended for nontin and nontin-alloy leadfinishes for 93+3/-5°C \ 1hrs. 2. Intended for tin and tin-alloy leadfinishes for 93+3/-5°C \ 8hrs. <jesd22-b102d, c="" condition=""></jesd22-b102d,> Solder pot temperature: 245±5°C, 5sec 									

Figure 1 (Cont.)

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	ENVIRONMENTAL REQUIREMENTS									
9	Resistance to Reflow Soldering Heat	No physical damage shall occur.	Pre-soak condition, 85°C/85% RH for 168 hrs. Pre Heat: 150~180°C, 90±30sec. Heat: 230°C Min., 30±10sec. Peak Temp.: 260+0/-5°C, 20~40sec. Duration: 3 cycles Tyco spec. 109-201, Condition B							
10	Thermal Shock	See Note	Mated Connector -55+/-3°C (30 min.), +85+/-2°C (30 min.) Perform this a cycle, repeat 5 cycles EIA-364-32C, Condition I							
11	Humidity-Temperature Cycle	See Note	Mated Connector 25~65°C, 90~95% RH, 10 Cycles EIA-364-31B.							
12	Temperature Life (Heat Aging)	See Note	Mated Connector 85°C, 250 hours, EIA-364-17B.							
13	Salt Spray	No detrimental corrosion allowed in contact area and base metal exposed.	Subject mated connectors to 35+/-2°C and 5+/-1% salt condition for 48hours. After test, rinse the sample with water and recondition the room temperature for 1 hour. EIA-364-26B, Condition B							

Figure 1 (End)

NOTE: Shall meet visual requirements, show no physical damage, and meet requirement of additional tests as specified in the test sequence in Figures 2

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3.6. PRODUCT QUALIFICATION AND REQUALIFICATION TEST

	Test Group									
Test or Examination	Α	В	С	D	Е	F	G	н		
		Test Sequence (a)								
Examination of Product		1,6	1,9	1,5	1,9	1,5	1,3	1,3		
Contact Resistance	2,4	2,5	4,6	2,4	4,6	2,4				
FPC Cable Retention Force										
Mechanical Shock		3								
Vibration		4								
Dielectric withstanding Voltage			3,8		3,8					
Insulation Resistance			2,7		2,7					
Thermal Shock			5							
Temperature Life				3						
Humidity Temperature Cycling					5					
Salt Spray						3				
Solder ability							2			
Resistance To Reflow Soldering Heat								2		

Figure 2

NOTE: (a) Numbers indicate sequence in which tests are performed.

(b) Discontinuities shall not take place in this test group, during tests.

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